

DUAL FREQUENCY CRYSTAL OSCILLATOR (XO) (10 MHz to 1.4 GHz)

Features

- Available with any-frequency output
 frequencies from 10 MHz to 945 MHz and select frequencies to 1.4 GHz
- Two selectable output frequencies
- 3rd generation DSPLL[®] with superior jitter performance
- 3x better frequency stability than SAW-based oscillators
- ensures high reliability and low aging Available CMOS, LVPECL,

Internal fixed crystal frequency

- LVDS, and CML outputs
- 3.3, 2.5, and 1.8 V supply options
 Industry-standard 5 x 7 mm
- package and pinout
- Pb-free/RoHS-compliant

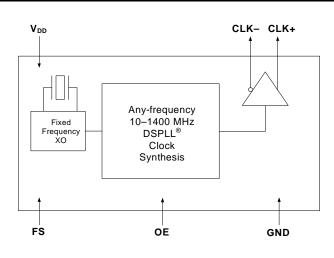
- **Applications**
- SONET/SDH
- Networking
- SD/HD video

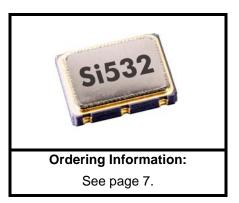
Description

- Test and measurementClock and data recovery
- FPGA/ASIC clock generation

The Si532 dual frequency XO utilizes Skyworks Solutions advanced DSPLL[®] circuitry to provide a low jitter clock at high frequencies. The Si532 is available with any-frequency output frequency from 10 to 945 MHz and select frequencies to 1400 MHz. Unlike a traditional XO where a different crystal is required for each output frequency, the Si532 uses one fixed crystal frequency to provide a wide range of output frequencies. This IC based approach allows the crystal resonator to provide exceptional frequency stability and reliability. In addition, DSPLL clock synthesis provides superior supply noise rejection, simplifying the task of generating low jitter clocks in noisy environments typically found in communication systems. The Si532 IC based XO is factory configurable for a wide variety of user specifications including frequency, supply voltage, output format, and temperature stability. Specific configurations are factory programmed at time of shipment, thereby eliminating long lead times associated with custom oscillators.

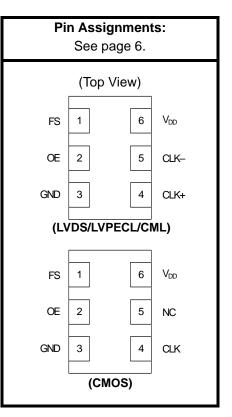
Functional Block Diagram





Si532

REVISION D



1. Electrical Specifications

Table 1. Recommended Operating Conditions

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Supply Voltage ¹	V _{DD}	3.3 V option	2.97	3.3	3.63	V
		2.5 V option	2.25	2.5	2.75	V
		1.8 V option	1.71	1.8	1.89	V
Supply Current	I _{DD}	Output enabled LVPECL CML LVDS CMOS	 	111 99 90 81	121 108 98 88	mA
		Tristate mode	—	60	75	mA
Output Enable (OE)		V _{IH}	$0.75 \mathrm{~x~V_{DD}}$	_	—	V
and Frequency Select (FS) ²		V _{IL}	—		0.5	V
Operating Temperature Range	T _A		-40	_	85	°C
Notos:			· · · · · ·			

Notes:

1. Selectable parameter specified by part number. See Section 3. "Ordering Information" on page 7 for further details.

2. OE and FS pins include a 17 k Ω pullup resistor to V_{DD}. Pulling OE to ground causes outputs to tristate.

Table 2. CLK± Output Frequency Characteristics

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Nominal Frequency ^{1,2}	f _O	LVPECL/LVDS/CML	10		945	MHz
		CMOS	10	—	160	MHz
Initial Accuracy	f _i	Measured at +25 °C at time of shipping	_	±1.5		ppm
Temperature Stability ^{1,3}			7 20 50		+7 +20 +50	ppm
Aging	f	Frequency drift over first year		_	±3	ppm
	f _a	Frequency drift over 20 year life	—	—	±10	ppm
Total Stability		Temp stability = ±7 ppm	_	_	±20	ppm
		Temp stability = ±20 ppm	_	—	±31.5	ppm
		Temp stability = ±50 ppm	_	_	±61.5	ppm

Notes:

1. See Section 3. "Ordering Information" on page 7 for further details.

2. Specified at time of order by part number. Also available in frequencies from 970 to 1134 MHz and 1213 to 1417 MHz.

3. Selectable parameter specified by part number.

4. Time from powerup or tristate mode to f_{O} .

Parameter	Symbol	Test Condition	Min	Тур	Мах	Units
Powerup Time ⁴	tosc		_	—	10	ms
Settling Time After FS Change	t _{FRQ}		_	_	10	ms
Notes: 1. See Section 3. "Orderin 2. Specified at time of order	• .	ige 7 for further details. Iso available in frequencies from 97	′0 to 1134 ľ	MHz and 12	213 to 141	I7 MHz.

3. Selectable parameter specified by part number.

4. Time from powerup or tristate mode to f_{O} .

Table 3. CLK± Output Levels and Symmetry
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Parameter	Symbol	Test	Condition	Min	Тур	Max	Units
LVPECL Output Option ¹	Vo	m	id-level	V _{DD} – 1.42	—	V _{DD} – 1.25	V
	V _{OD}	sw	ing (diff)	1.1		1.9	V _{PP}
	V _{SE}	swing (s	single-ended)	0.55		0.95	V _{PP}
LVDS Output Option ²	Vo	m	id-level	1.125	1.20	1.275	V
	V _{OD}	sw	swing (diff)		0.7	0.9	V _{PP}
CML Output Option ²	V	2.5/3.3 V	option mid-level	—	V _{DD} – 1.30		V
	Vo	1.8 V option mid-level		—	V _{DD} – 0.36	_	V
	V	2.5/3.3 V option swing (diff)		1.10	1.50	1.90	V _{PP}
	V _{OD}	1.8 V opt	ion swing (diff)	0.35	0.425	0.50	V _{PP}
CMOS Output Option ³	V _{OH}	I _{OH}	= 32 mA	0.8 x V _{DD}	_	V _{DD}	V
	V _{OL}	I _{OL}	= 32 mA	—	_	0.4	
Rise/Fall time (20/80%)	t _{R,} t _F	LVPEC	L/LVDS/CML	—	_	350	ps
		CMOS w	with $C_L = 15 \text{ pF}$	—	1	_	ns
Symmetry (duty cycle)	SYM	LVPECL: (diff) LVDS: CMOS:	V _{DD} – 1.3 V 1.25 V (diff) V _{DD} /2	45		55	%
 Notes: 50 Ω to V_{DD} - 2.0 V. R_{term} = 100 Ω (differe C₁ = 15 pF 	ntial).						

Table 4. CLK± Output Phase Jitter

Symbol	mbol Test Condition		Тур	Max	Units
фJ	12 kHz to 20 MHz (OC-48)		0.25	0.40	ps
	50 kHz to 80 MHz (OC-192)		0.26	0.37	ps
фJ	12 kHz to 20 MHz (OC-48)	_	0.36	0.50	ps
	50 kHz to 80 MHz (OC-192) ²		0.34	0.42	ps
φJ	12 kHz to 20 MHz (Brickwall)	_	0.25	0.40	ps
фJ	12 kHz to 20 MHz (OC-48) ²		0.62		ps
	50 kHz to 20 MHz ²	_	0.61	_	ps
	φ _J φ _J φ _J				$ \begin{array}{c c c c c c c c c c c c c c c c c c c $

Notes:

1. Refer to AN256 for further information.

2. Max offset frequencies: 80 MHz for FOUT > 250 MHz, 20 MHz for 50 MHz < FOUT <250 MHz,

2 MHz for 10 MHz <u><</u> FOUT <50 MHz.

Table 5. CLK± Output Period Jitter

Parameter	Symbol	Test Condition	Min	Тур	Max	Units	
Period Jitter*	J _{PER}	RMS	—	2	_	ps	
		Peak-to-Peak	—	14	_	ps	
*Note: Any output mode, including CMOS, LVPECL, LVDS, CML. N = 1000 cycles. Refer to AN279 for further information.							

Table 6. CLK± Output Phase Noise (Typical)

Offset Frequency (f)	120.00 MHz LVDS	156.25 MHz LVPECL	622.08 MHz LVPECL	Units
100 Hz	-112	-105	-97	
1 kHz	-122	-122	-107	
10 kHz	-132	-128	-116	
100 kHz	-137	-135	-121	dBc/Hz
1 MHz	-144	-144	-134	
10 MHz	-150	-147	-146	
100 MHz	n/a	n/a	-148	

Table 7. Environmental Compliance

The Si532 meets the following qualification test requirements.

Parameter	Conditions/Test Method
Mechanical Shock	MIL-STD-883, Method 2002
Mechanical Vibration	MIL-STD-883, Method 2007
Solderability	MIL-STD-883, Method 2003
Gross & Fine Leak	MIL-STD-883, Method 1014
Resistance to Solder Heat	MIL-STD-883, Method 2036
Moisture Sensitivity Level	J-STD_020, MSL1
Contact Pads	Gold over Nickel

Table 8. Thermal Characteristics

(Typical values TA = 25 °C, V_{DD} = 3.3 V)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Thermal Resistance Junction to Ambient	θ_{JA}	Still Air	—	84.6	_	°C/W
Thermal Resistance Junction to Case	θ_{JC}	Still Air	—	38.8	_	°C/W
Ambient Temperature	Τ _Α		-40	_	85	°C
Junction Temperature	Т _Ј		_		125	°C

Table 9. Absolute Maximum Ratings¹

Parameter	Symbol	Rating	Units
Maximum Operating Temperature	T _{AMAX}	85	٥C
Supply Voltage, 1.8 V Option	V _{DD}	-0.5 to +1.9	V
Supply Voltage, 2.5/3.3 V Option	V _{DD}	-0.5 to +3.8	V
Input Voltage (any input pin)	VI	-0.5 to V _{DD} + 0.3	V
Storage Temperature	Τ _S	-55 to +125	٥C
ESD Sensitivity (HBM, per JESD22-A114)	ESD	2500	V
Soldering Temperature (Pb-free profile) ²	T _{PEAK}	260	٥C
Soldering Temperature Time @ T _{PEAK} (Pb-free profile) ²	t _P	20–40	seconds

Notes:

1. Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Functional operation or specification compliance is not implied at these conditions.

 The device is compliant with JEDEC J-STD-020C. Refer to Si5xx Packaging FAQ available for download at www.skyworksinc.com/en/application-pages/timing-lookup-customize for further information, including soldering profiles.

2. Pin Descriptions

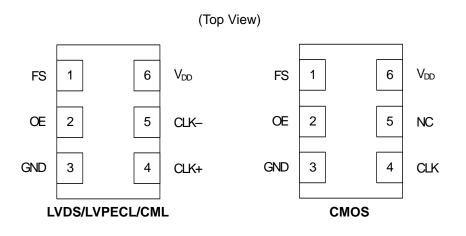


Table 10. Pin Descriptions

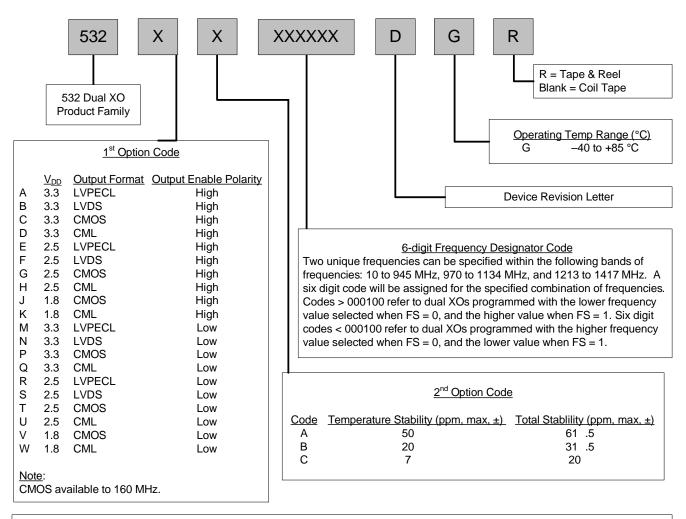
Pin	Symbol	LVDS/LVPECL/CML Function	CMOS Function		
		Frequency Select	Frequency Select		
1	FS*	0 = First frequency selected	0 = First frequency selected		
		1 = Second frequency selected	1 = Second frequency selected		
		Output enable	Output enable		
2	OE*	0 = clock output disabled (outputs tristated)	0 = clock output disabled (outputs tristated)		
		1 = clock output enabled	1 = clock output enabled		
3	GND	Electrical and Case Ground	Electrical and Case Ground		
4	CLK+	Oscillator Output	Oscillator Output		
5	CLK–	Complementary Output	No connection		
6	V _{DD}	Power Supply Voltage	Power Supply Voltage		
*Note	*Note: FS and OE include a 17 kΩ pullup resistor to V _{DD} . See Section 3. "Ordering Information" for details on frequency value ordering.				

3. Ordering Information

The Si532 XO supports a variety of options including frequency, temperature stability, output format, and V_{DD} . Specific device configurations are programmed into the Si532 at time of shipment. Configurations can be specified using the Part Number Configuration chart below. Skyworks Solutions Laboratories provides a web browser-based part number configuration utility to simplify this process.

Refer to www.skyworksinc.com/en/application-pages/timing-lookup-customize

to access this tool and for further ordering instructions. The Si532 is supplied in an industry-standard, RoHS-compliant, 6-pad, 5 x 7 mm package.



Example Part Number: 532AB000108DGR is a 5 x 7 mm Dual XO in a 6 pad package. Since the six digit code (000108) is > 000100, f0 is 644.53125 MHz (lower frequency) and f1 is 693.48299 (higher frequency), with a 3.3 V supply, LVPECL output, and Output Enable active high polarity. Temperature stability is specified as ± 20 ppm. The part is specified for a -40 to +85 C° ambient temperature range operation and is shipped in tape and reel format.

Figure 1. Part Number Convention

Downloaded from Arrow.com.

4. Outline Diagram and Suggested Pad Layout

Figure 2 illustrates the package details for the Si532. Table 11 lists the values for the dimensions shown in the illustration.

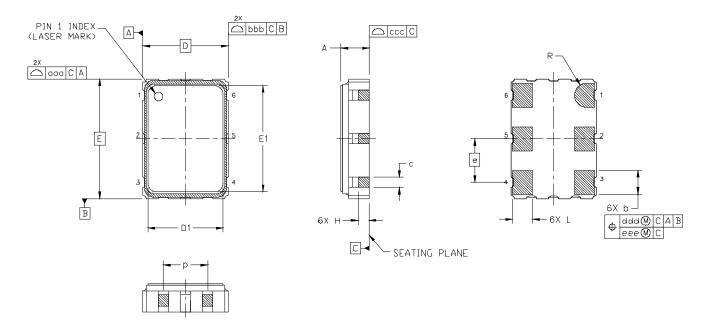


Figure 2. Si532 Outline Diagram

Dimension	Min	Nom	Max
A	1.50	1.65	1.80
b	1.30	1.40	1.50
С	0.50	0.60	0.70
D		5.00 BSC	
D1	4.30	4.40	4.50
e	2.54 BSC		
E	7.00 BSC		
E1	6.10	6.20	6.30
Н	0.55	0.65	0.75
L	1.17	1.27	1.37
р	1.80	—	2.60
R	0.70 REF		
aaa	0.15		
bbb	0.15		
CCC	0.10		
ddd	0.10		
eee	0.05		

Table 11. Package Diagram Dimensions (mm)

5. Si532 Mark Specification

Figure 3 illustrates the mark specification for the Si532. Table 12 lists the line information.

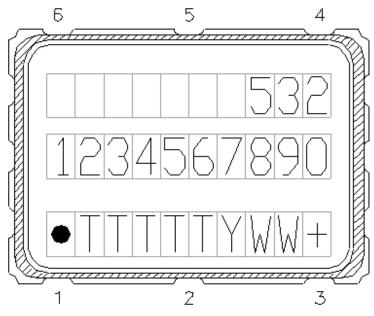


Figure 3. Mark Specification

Table 12. Si53x Top Mark Description

Line	Position	Description	
1 1–10		"532"	
2 1–10 Si532: Option1 + Option2 + Con		Si532: Option1 + Option2 + ConfigNum(6) + Temp	
3	Trace Code		
	Position 1	Pin 1 orientation mark (dot)	
	Position 2	Product Revision (D)	
	Position 3–6	Tiny Trace Code (4 alphanumeric characters per assembly release instructions)	
	Position 7	Year (least significant year digit), to be assigned by assembly site (ex: 2007 = 7)	
	Position 8–9	Calendar Work Week number (1–53), to be assigned by assembly site	
	Position 10	"+" to indicate Pb-Free and RoHS-compliant	

6. 6-Pin PCB Land Pattern

Figure 4 illustrates the 6-pin PCB land pattern for the Si532. Table 13 lists the values for the dimensions shown in the illustration.

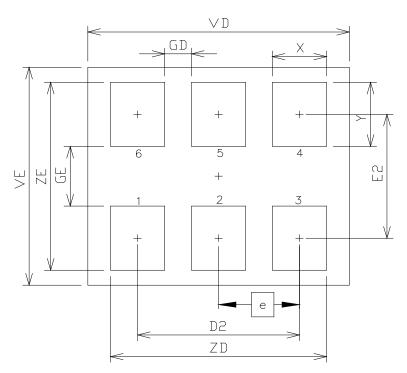


Figure 4. Si532 PCB Land Pattern

Table 13. PCB Land Pattern Dim	nensions (mm)
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Dimension	Min	Мах	
D2	5.08 REF		
е	2.54 BSC		
E2	4.15 REF		
GD	0.84	—	
GE	2.00	—	
VD	8.20 REF		
VE	7.30 REF		
Х	1.70 TYP		
Y	2.15 REF		
ZD	— 6.78		
ZE	—	6.30	
Natas			

Notes:

1. Dimensioning and tolerancing per the ANSI Y14.5M-1994 specification.

2. Land pattern design based on IPC-7351 guidelines.

3. All dimensions shown are at maximum material condition (MMC).

4. Controlling dimension is in millimeters (mm).

DOCUMENT CHANGE LIST

Revision 1.0 to Revision 1.1

- Updated Table 1, "Recommended Operating Conditions," on page 2.
 - Device maintains stable operation over -40 to +85 °C operating temperature range.
 - Supply current specifications updated for revision D.
- Updated Table 2, "CLK± Output Frequency Characteristics," on page 2.
 - Added specification for ±20 ppm lifetime stability (±7 ppm temperature stability) XO.
- Updated Table 3, "CLK± Output Levels and Symmetry," on page 3.
 - Updated LVDS differential peak-peak swing specifications.
- Updated Table 4, "CLK± Output Phase Jitter," on page 4.
- Updated Table 5, "CLK± Output Period Jitter," on page 4.
 - Revised period jitter specifications.
- Updated Table 9, "Absolute Maximum Ratings¹," on page 5 to reflect the soldering temperature time at 260 °C is 20–40 sec per JEDEC J-STD-020C.
- Updated 3. "Ordering Information" on page 7.
 Changed ordering instructions to revision D.
- Added 5. "Si532 Mark Specification" on page 9.

Revision 1.1 to Revision 1.2

- Updated 2.5 V/3.3 V and 1.8 V CML output level specifications for Table 3 on page 3.
- Added footnotes clarifying max offset frequency test conditions for Table 4 on page 4.
- Removed the words "Differential Modes: LVPECL/LVDS/CML" in the footnote referring to AN256 in Table 4 on page 4.
- Added CMOS phase jitter specs to Table 4 on page 4.
- Updated Table 7 on page 5 to include the "Moisture Sensitivity Level" and "Contact Pads" rows.
- Revised Figure 2 on page 8 to reflect current package outline diagram.
- Updated Figure 3 and Table 12 on page 9 to reflect specific marking information. Previously, Figure 3 was generic.

Revision 1.2 to Revision 1.3

 Added Table 8, "Thermal Characteristics," on page 5.

Revision 1.3 to Revision 1.31

May 2, 2016

 Updated Table 4 to include 125 MHz and 156.25 MHz jitter measurements.

Revision 1.31 to Revision 1.4

June, 2018

 Changed "Trays" to "Coil Tape" in section 3. "Ordering Information".

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